

# AMERICAN MICROSEMI CONDUCTOR INC.

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## NPN SILICON RF SMALL-SIGNAL TRANSISTORS

... designed primarily for use in high-gain, low-noise, small-signal amplifiers in military and industrial equipment. Suitable for use in video wideband and general high-frequency amplifier applications of 50 to 1000 MHz.

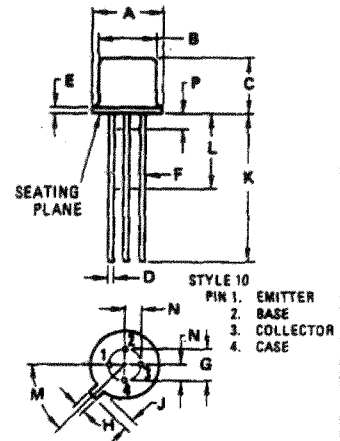
- Low Noise Figure –  
 $NF = 2.2 \text{ dB (Typ) @ } f = 200 \text{ MHz} - \text{MM8006}$
- High Power Gain –  
 $G_{pe} = 25 \text{ dB (Typ) @ } f = 200 \text{ MHz} - \text{MM8006}$
- High Current-Gain-Bandwidth Product –  
 $f_T = 1000 \text{ MHz (Min) @ } I_C = 5.0 \text{ mAdc}$

## MM8006 (SILICON) MM8007

### NPN SILICON RF SMALL-SIGNAL TRANSISTORS

### MAXIMUM RATINGS

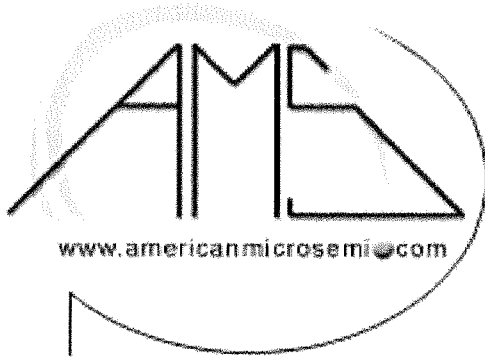
Rating	Symbol	Value	Unit
Collector-Emitter Voltage	$V_{CE0}$	10	Vdc
Collector-Base Voltage	$V_{CB}$	15	Vdc
Emitter-Base Voltage	$V_{EB}$	3.0	Vdc
Collector Current – Continuous	$I_C$	20	mAdc
Total Device Dissipation @ $T_A = 25^\circ\text{C}$ Derate above $25^\circ\text{C}$	$P_D$	200	mW
		1.14	mW/ $^\circ\text{C}$
Operating and Storage Junction Temperature Range	$T_J, T_{stg}$	-65 to +200	$^\circ\text{C}$



DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	5.31	5.84	0.209	0.230
B	4.52	4.95	0.178	0.195
C	4.32	5.33	0.170	0.210
D	0.41	0.53	0.016	0.021
E	—	0.76	—	0.030
F	0.41	0.48	0.016	0.019
G	2.54 BSC	—	0.100 BSC	—
H	0.91	1.17	0.036	0.046
J	0.71	1.22	0.028	0.048
K	12.70	—	0.500	—
L	6.35	—	0.250	—
M	45 $^\circ$ BSC	—	45 $^\circ$ BSC	—
N	1.27 BSC	—	0.050 BSC	—
P	—	1.27	—	0.050

ALL JEDEC dimensions and notes apply

CASE 20-03  
TO-72



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## ELECTRICAL CHARACTERISTICS ( $T_A = 25^\circ\text{C}$ unless otherwise noted)

Characteristic	Symbol	Min	Typ	Max	Unit
<b>OFF CHARACTERISTICS</b>					
Collector-Emitter Breakdown Voltage ( $I_C = 1.0 \text{ mA dc}$ , $I_B = 0$ )	$BV_{CEO}$	10	—	—	Vdc
Collector-Base Breakdown Voltage ( $I_C = 0.01 \text{ mA dc}$ , $I_E = 0$ )	$BV_{CBO}$	15	—	—	Vdc
Emitter-Base Breakdown Voltage ( $I_E = 0.01 \text{ mA dc}$ , $I_C = 0$ )	$BV_{EBO}$	3.0	—	—	Vdc
Collector Cutoff Current ( $V_{CB} = 6.0 \text{ Vdc}$ , $I_E = 0$ )	$I_{CBO}$	—	1.0	10	nA dc
<b>ON CHARACTERISTICS</b>					
DC Current Gain ( $I_C = 1.0 \text{ mA dc}$ , $V_{CE} = 6.0 \text{ Vdc}$ )	$h_{FE}$	25	—	—	—
<b>DYNAMIC CHARACTERISTICS</b>					
Current-Gain—Bandwidth Product ( $I_C = 5.0 \text{ mA dc}$ , $V_{CE} = 6.0 \text{ Vdc}$ , $f = 100 \text{ MHz}$ )	$f_T$	1000	—	3500	MHz
Collector-Base Capacitance ( $V_{CE} = 6.0 \text{ Vdc}$ , $I_E = 0$ , $f = 0.1 \text{ MHz}$ )	$C_{cb}$	—	1.1	1.5	pF
Collector-Base Time Constant ( $I_C = 10 \text{ mA dc}$ , $V_{CE} = 6.0 \text{ Vdc}$ , $f = 31.8 \text{ MHz}$ )	$r_b' C_c$	—	5.0	—	ps
Noise Figure ( $I_C = 1.0 \text{ mA dc}$ , $V_{CE} = 6.0 \text{ Vdc}$ , $f = 60 \text{ MHz}$ )	NF	—	1.5	—	dB
( $I_C = 1.0 \text{ mA dc}$ , $V_{CE} = 6.0 \text{ Vdc}$ , $f = 200 \text{ MHz}$ )		—	1.9	—	
$f$ ( $I_C = 1.0 \text{ mA dc}$ , $V_{CE} = 6.0 \text{ Vdc}$ , $f = 450 \text{ MHz}$ )	MM8006	—	2.2	—	—
	MM8007	—	2.7	—	
$f$ ( $I_C = 1.0 \text{ mA dc}$ , $V_{CE} = 6.0 \text{ Vdc}$ , $f = 450 \text{ MHz}$ )	MM8006	—	—	3.8	—
	MM8007	—	—	5.0	
<b>FUNCTIONAL TEST</b>					
Common-Emitter Amplifier Power Gain ( $I_C = 1.0 \text{ mA dc}$ , $V_{CE} = 6.0 \text{ Vdc}$ , $f = 60 \text{ MHz}$ )	$G_{pe}$	Both Types	—	30	dB
( $I_C = 1.0 \text{ mA dc}$ , $V_{CE} = 6.0 \text{ Vdc}$ , $f = 200 \text{ MHz}$ )		MM8006	—	25	
( $I_C = 1.0 \text{ mA dc}$ , $V_{CE} = 6.0 \text{ Vdc}$ , $f = 450 \text{ MHz}$ )	MM8007	—	20	—	
	MM8006	14	—	—	
	MM8007	12	—	—	

<sup>†</sup>Tuned for minimum noise.

FIGURE 1 — POWER GAIN AND NOISE FIGURE TEST CIRCUIT

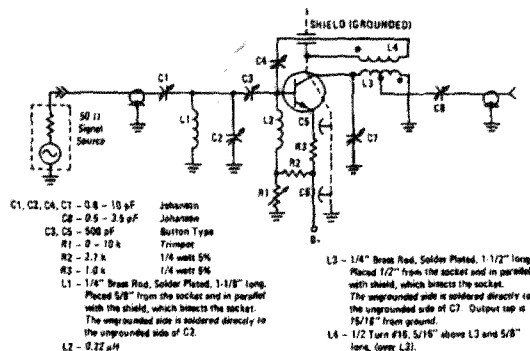


FIGURE 2 — COLLECTOR-BASE CAPACITANCE versus VOLTAGE

